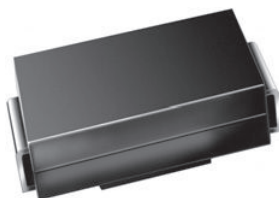


## Standard Avalanche SMD Rectifier



DO-214AC (SMA)

### FEATURES

- Low profile package
- Ideal for automated placement
- Controlled avalanche characteristics
- Glass passivated junction
- Low reverse current
- High surge current capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT

### TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

### MECHANICAL DATA

**Case:** DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-E3 - RoHS-compliant, commercial grade  
Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 2 whisker test, HE3 suffix meets JESD 201 class 2 whisker test

#### Note

- BYG10Y for commercial grade only

**Polarity:** Color band denotes the cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.5 A
$V_{RRM}$	200 V, 400 V, 600 V, 800 V, 1000 V, 1600 V
$I_{FSM}$	30 A
$I_R$	1.0 $\mu$ A
$V_F$	1.15 V
$E_R$	20 mJ
$T_J$ max.	150 °C
Package	DO-214AC (SMA)
Diode variations	Single die

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)								
PARAMETER	SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT
Device marking code		BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	
Maximum repetitive peak reverse voltage	$V_{RRM}$	200	400	600	800	1000	1600	V
Average forward current	$I_{F(AV)}$	1.5						A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	30						A
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1$ A, $T_J = 25$ °C (for BYG10D thru BYG10M) $I_{(BR)R} = 0.4$ A, $T_J = 25$ °C (for BYG10Y)	$E_R$	20						mJ
Operating junction and storage temperature range	$T_J, T_{STG}$	- 55 to + 150						°C



ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT
Maximum instantaneous forward voltage <sup>(1)</sup>	I <sub>F</sub> = 1 A	T <sub>J</sub> = 25 °C	V <sub>F</sub>	1.1						V
	I <sub>F</sub> = 1.5 A			1.15						
Maximum DC reverse current	V <sub>R</sub> = V <sub>RRM</sub>	T <sub>J</sub> = 25 °C	I <sub>R</sub>	1						μA
		T <sub>J</sub> = 100 °C		10						
Maximum reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A		t <sub>rr</sub>	4						μs

## Note

<sup>(1)</sup> Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT
Typical thermal resistance, junction to lead	R <sub>θJL</sub>	25						°C/W
Typical thermal resistance, junction to ambient	R <sub>θJA</sub> <sup>(1)</sup>	150						°C/W
	R <sub>θJA</sub> <sup>(2)</sup>	125						
	R <sub>θJA</sub> <sup>(3)</sup>	100						

## Notes

- <sup>(1)</sup> Mounted on epoxy-glass hard tissue  
<sup>(2)</sup> Mounted on epoxy-glass hard tissue, 50 mm<sup>2</sup> 35  $\mu\text{m}$  Cu  
<sup>(3)</sup> Mounted on Al-oxide-ceramic ( $\text{Al}_2\text{O}_3$ ), 50 mm<sup>2</sup> 35  $\mu\text{m}$  Cu

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
BYG10D-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG10D-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG10DHE3/TR <sup>(1)</sup>	0.064	TR	1800	7" diameter plastic tape and reel
BYG10DHE3/TR3 <sup>(1)</sup>	0.064	TR3	7500	13" diameter plastic tape and reel

## Note

<sup>(1)</sup> AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

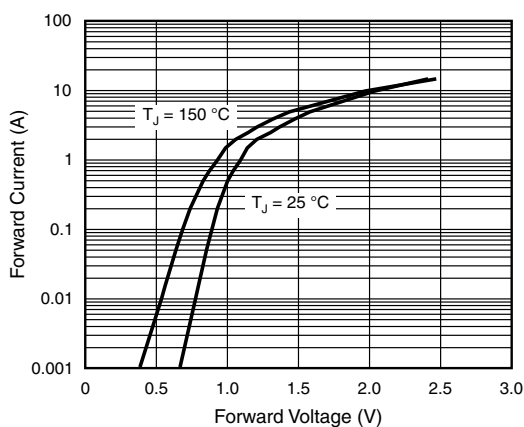


Fig. 1 - Forward Current vs. Forward Voltage

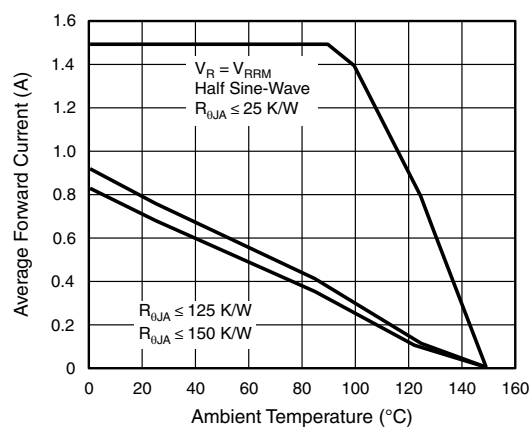


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

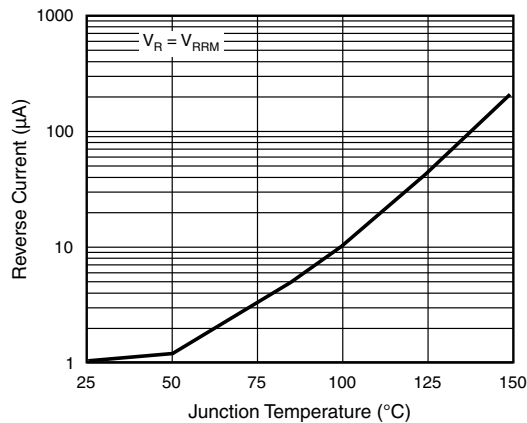


Fig. 3 - Reverse Current vs. Junction Temperature

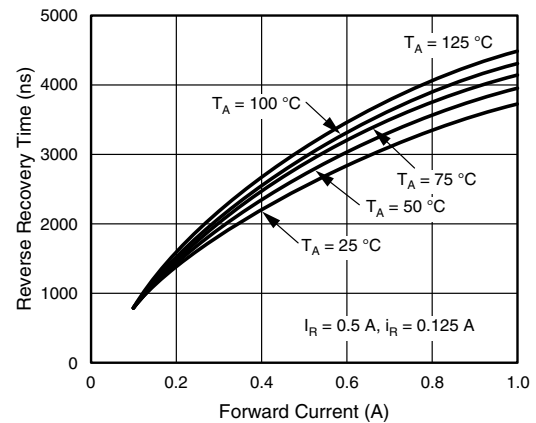


Fig. 6 - Reverse Recovery Time vs. Forward Current

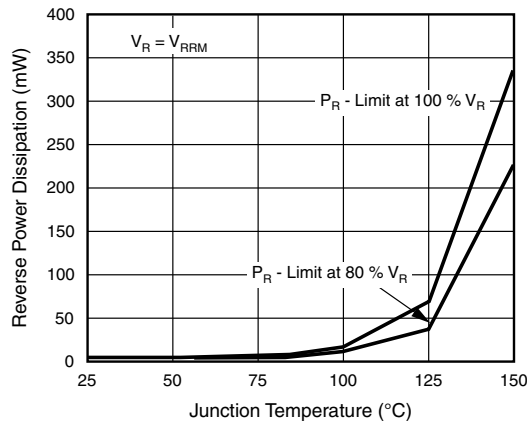


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

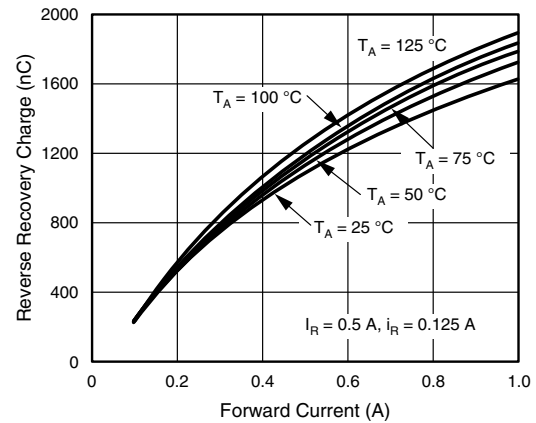


Fig. 7 - Reverse Recovery Charge vs. Forward Current

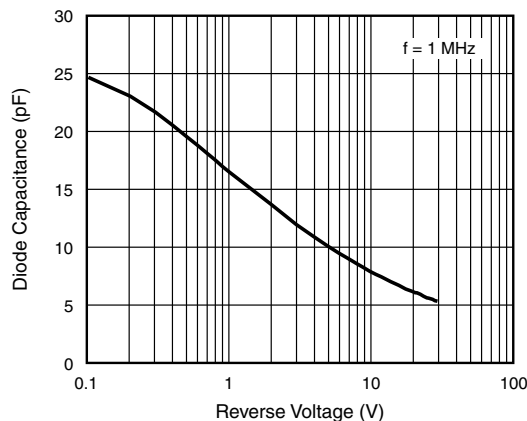
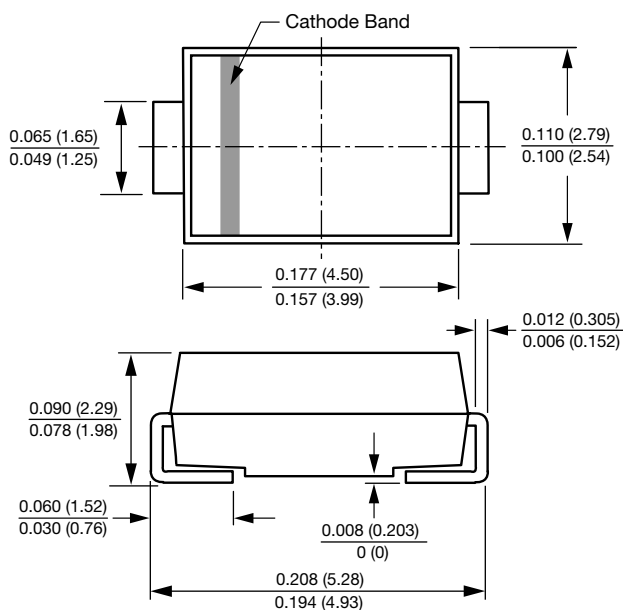


Fig. 5 - Diode Capacitance vs. Reverse Voltage

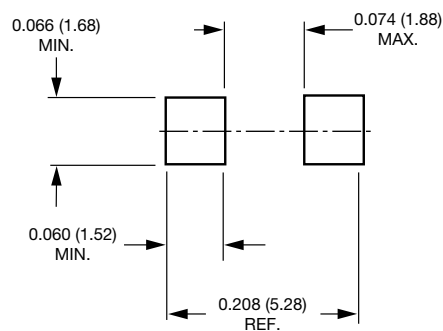


## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### DO-214AC (SMA)



### Mounting Pad Layout





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